The CD4047B-Series types are supplied in 14-lead hermetic dual-in-line ceramic packages (F3A suffix), 14-lead dual-in-line plastic packages (E suffix), 14-lead small-outline packages (M, MT, M96, and NSR suffixes), and 14-lead thin shrink small-outline packages (PW and PWR suffixes).

The CD4047B triggers in the monostable mode when a positive-going edge occurs on the +TRIGGER input while the -TRIGGER is held low. Input pulses may be of any duration relative to the output pulse.

If retrigger capability is desired, the RETRIGGER input is pulsed. The retriggerable mode of operation is limited to positive-going edge. The CD4047B will retrigger as long as the RETRIGGER input is high, with or without transitions (See Fig. 34).

An external countdown option can be implemented by coupling “Q” to an external “N” counter and resetting the counter with the trigger pulse. The counter output pulse is fed back to the ASTABLE input and has a duration equal to N times the period of the multivibrator.

A high level on the EXTERNAL RESET input assures no output pulse during an “ON” power condition. This input can also be activated to terminate the output pulse at any time. For monostable operation, whenever \( V_{DD} \) is applied, an internal power-on reset circuit will clock the Q output low within one output period (\( t_q \)).

The CD4047B-Series types are supplied in 14-lead hermetic dual-in-line ceramic packages (F3A suffix), 14-lead dual-in-line plastic packages (E suffix), 14-lead small-outline packages (M, MT, M96, and NSR suffixes), and 14-lead thin shrink small-outline packages (PW and PWR suffixes).

### CMOS Low-Power Monostable/Astable Multivibrator

High Voltage Types (20-Volt Rating)

- **CD4047B** consists of a gatable astable multivibrator with logic techniques incorporated to permit positive or negative edge-triggered monostable multivibrator action with retriggering and external counting options.

Inputs include +TRIGGER, -TRIGGER, ASTABLE, ASTABLE, RETRIGGER, and EXTERNAL RESET. Buffered outputs are \( Q \), \( \bar{Q} \), and OSCILLATOR. In all modes of operation, and external capacitor must be connected between C-Timing and RC-Common terminals, and an external resistor must be connected between the R-Timing and RC-Common terminals.

Astable operation is enabled by a high level on the ASTABLE input or a low level on the ASTABLE input, or both. The period of the square wave at the Q and \( \bar{Q} \) Outputs in this mode of operation is a function of the external components employed. “True” input pulses on the ASTABLE input or “Complement” pulses on the ASTABLE input allow the circuit to be used as a gatable multivibrator. The OSCILLATOR output period will be half of the Q terminal output in the astable mode. However, a 50% duty cycle is not guaranteed at this output.

The CD4047B triggers in the monostable mode when a positive-going edge occurs on the +TRIGGER input while the -TRIGGER is held low. Input pulses may be of any duration relative to the output pulse.

If retrigger capability is desired, the RETRIGGER input is pulsed. The retriggerable mode of operation is limited to positive-going edge. The CD4047B will retrigger as long as the RETRIGGER input is high, with or without transitions (See Fig. 34).

An external countdown option can be implemented by coupling “Q” to an external “N” counter and resetting the counter with the trigger pulse. The counter output pulse is fed back to the ASTABLE input and has a duration equal to N times the period of the multivibrator.

A high level on the EXTERNAL RESET input assures no output pulse during an “ON” power condition. This input can also be activated to terminate the output pulse at any time. For monostable operation, whenever \( V_{DD} \) is applied, an internal power-on reset circuit will clock the Q output low within one output period (\( t_q \)).

The CD4047B-Series types are supplied in 14-lead hermetic dual-in-line ceramic packages (F3A suffix), 14-lead dual-in-line plastic packages (E suffix), 14-lead small-outline packages (M, MT, M96, and NSR suffixes), and 14-lead thin shrink small-outline packages (PW and PWR suffixes).

### CD4047B Types

**Features:**
- Low power consumption: special CMOS oscillator configuration
- Monostable (one-shot) or astable (free-running) operation
- True and complemented buffered outputs
- Only one external R and C required
- Buffered inputs
- 100% tested for quiescent current at 20 V
- Standardized, symmetrical output characteristics
- 5-V, 10-V, and 15-V parametric ratings

**Monostable Multivibrator Features:**
- Positive- or negative-edge trigger
- Output pulse width independent of trigger pulse duration
- Retriggerable option for pulse width expansion
- Internal power-off reset circuit
- Long pulse widths possible using small RC components by means of external counter provision
- Fast recovery time essentially independent of pulse width
- Pulse-width accuracy maintained at duty cycles approaching 100%

**Astable Multivibrator Features:**
- Free-running or gatable operating modes
- 50% duty cycle
- Oscillator output available
- Good astable frequency stability:
  - Frequency deviation: \( \pm 2\% + 0.03\%/{ }^\circ C \) @ 10 kHz
  - \( \pm 0.5\% + 0.015\%/^\circ C \) @ 10 kHz
  (circuits “trimmed” to frequency \( V_{DD} = 10 \text{ V} \pm 10\% \))

**Applications:**
- Digital equipment where low-power dissipation and high noise immunity are primary design requirements:
  - Envelope detection
  - Frequency multiplication
  - Frequency division
  - Frequency discriminators
  - Timing circuits
  - Time-delay applications

### RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

<table>
<thead>
<tr>
<th>CHARACTERISTIC</th>
<th>LIMITS</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Supply-Voltage Range (For ( T_A = \text{Full Package-Temperature Range} ))</td>
<td>3</td>
<td>18</td>
</tr>
</tbody>
</table>

**NOTE:** IF AT 15 V OPERATION A 10 MΩ RESISTOR IS USED THE OPERATING TEMPERATURE SHOULD BE BETWEEN -25°C and 100°C

### MAXIMUM RATINGS, Absolute-Maximum Values:

- **DC SUPPLY-VOLTAGE RANGE (\( V_{DD} \)):**
  - Voltages referenced to \( V_{DD} \) terminals
  - \(-0.5\text{V} \) to \(+20\text{V}\)

- **INPUT VOLTAGE RANGE, ALL INPUTS:**
  - \(-0.5\text{V} \) to \(+0.5\text{V}\)

- **DC INPUT CURRENT, ANY ONE INPUT:**
  - \(+10\text{mA}\)

- **POWER DISSIPATION PER PACKAGE (\( P_{D} \)):**
  - For \( T_A = -55°C \) to \(+100°C \)
  - \( 500\text{mW} \)
  - For \( T_A = +100°C \) to \(+125°C \)
  - Derate Linearity at 12 mW/ºC to 200 mW

- **DEVICE DISSIPATION PER OUTPUT TRANSISTOR:**
  - For \( T_A = \text{Full Package-Temperature Range} \) (All Package Types)
  - \( 100\text{mW} \)

- **OPERATING-TEMPERATURE RANGE (\( T_A \)):**
  - \(-65°C \) to \(+125°C \)

- **STORAGE TEMPERATURE RANGE (\( T_J \)):**
  - \(-65°C \) to \(+150°C \)

- **LEAD TEMPERATURE (DURING SOLDERING):**
  - At distance 1/16 ± 1/32 inch (1.59 ± 0.79 mm) from case for 10s max
  - \(+265°C \)

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CD4047B Types

**CD4047B FUNCTIONAL TERMINAL CONNECTIONS**

**NOTE:** IN ALL CASES EXTERNAL RESISTOR BETWEEN TERMINALS 2 AND 3

EXTERNAL CAPACITOR BETWEEN TERMINALS 1 AND 3

<table>
<thead>
<tr>
<th>FUNCTION</th>
<th>TERMINAL CONNECTIONS TO VDD</th>
<th>TERMINAL CONNECTIONS TO VSS</th>
<th>INPUT TO</th>
<th>OUTPUT PULSE FROM</th>
<th>OUTPUT PERIOD OR PULSE WIDTH</th>
</tr>
</thead>
<tbody>
<tr>
<td>Astable Multivibrator: Free Running</td>
<td>4,5,6,14</td>
<td>7,8,9,12</td>
<td>-</td>
<td>10,11,13</td>
<td>IA (10,11) = 4.40 RC</td>
</tr>
<tr>
<td>True Gating</td>
<td>4,6,14</td>
<td>7,8,9,12</td>
<td>5</td>
<td>10,11,13</td>
<td>IA (13) = 2.20 RC</td>
</tr>
<tr>
<td>Complement Gating</td>
<td>5,14</td>
<td>5,7,8,9,12</td>
<td>4</td>
<td>10,11,13</td>
<td>-</td>
</tr>
<tr>
<td>Monostable Multivibrator: Positive-Edge Trigger</td>
<td>4,14</td>
<td>5,6,7,9,12</td>
<td>8</td>
<td>10,11</td>
<td>IM (10,11) = 2.48 RC</td>
</tr>
<tr>
<td>Negative-Edge Trigger</td>
<td>4,14</td>
<td>5,7,9,12</td>
<td>6</td>
<td>10,11</td>
<td></td>
</tr>
<tr>
<td>Retriggerable</td>
<td>4,14</td>
<td>5,6,7,9</td>
<td>8,12</td>
<td>10,11</td>
<td></td>
</tr>
<tr>
<td>External Countdown*</td>
<td>14</td>
<td>5,6,7,8,9,12</td>
<td>-</td>
<td>10,11</td>
<td></td>
</tr>
</tbody>
</table>

*See Text.

# First positive ½ cycle pulse-width = 2.48 RC, see Note on Page 3-134.

*Input Pulse to Reset of External Counting Chip External Counting Chip Output To Terminal 4

---

**Fig. 1—CD4047B logic block diagram.**

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**Fig. 2—CD4047B logic diagram.**
CD4047B Types

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Fig. 3—Detail logic diagram for flip-flops FF1 and FF3 (a) and for flip-flops FF2 and FF4 (b).

---

Fig. 4—Typical output high (sink) current characteristics.

---

Fig. 5—Minimum output low (sink) current characteristics.

---

Fig. 6—Typical output high (source) current characteristics.

---

Fig. 7—Minimum output high (source) current characteristics.

---

Fig. 8—Typical propagation delay time as a function of load capacitance (Astable, Asstable to Q, Q).

---

Fig. 9—Typical propagation delay time as a function of load capacitance (+ or − trigger to Q, Q).

---

STATIC ELECTRICAL CHARACTERISTICS

<table>
<thead>
<tr>
<th>CHARACTERISTICS</th>
<th>CONDITIONS</th>
<th>LIMITS AT INDICATED TEMPERATURES (°C)</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>Vf (V)</td>
<td>VIN (V)</td>
<td>VDD (V)</td>
</tr>
<tr>
<td>Quiescent</td>
<td>0.5</td>
<td>5</td>
<td>1</td>
</tr>
<tr>
<td>Device Current, IDD Max.</td>
<td>0.10</td>
<td>10</td>
<td>2</td>
</tr>
<tr>
<td>Output Low (Sink)</td>
<td>0.4</td>
<td>0.5</td>
<td>0.64</td>
</tr>
<tr>
<td>Current IOL Min.</td>
<td>0.5</td>
<td>0.10</td>
<td>1.6</td>
</tr>
<tr>
<td>Output High (Source)</td>
<td>1.5</td>
<td>0.15</td>
<td>15</td>
</tr>
<tr>
<td>(Source)</td>
<td>2.5</td>
<td>0.10</td>
<td>10</td>
</tr>
<tr>
<td>Current, IOL Min.</td>
<td>9.5</td>
<td>0.15</td>
<td>15</td>
</tr>
<tr>
<td>Output Voltage: Low- Level VOL Max.</td>
<td>0.5</td>
<td>0.15</td>
<td>5</td>
</tr>
</tbody>
</table>
### STATIC ELECTRICAL CHARACTERISTICS (CONTINUED)

<table>
<thead>
<tr>
<th>CHARACTERISTICS</th>
<th>CONDITIONS</th>
<th>LIMITS AT INDICATED TEMPERATURES (°C)</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td>VDD (V)</td>
<td>VOUT (V)</td>
</tr>
<tr>
<td>Output Voltage</td>
<td>—</td>
<td>—</td>
<td>0.5</td>
</tr>
<tr>
<td>Age: High-Level, VOH Min.</td>
<td>—</td>
<td>0.15</td>
<td>10</td>
</tr>
<tr>
<td>Input Low Voltage, VIL Max.</td>
<td>0.5, 4.5</td>
<td>5</td>
<td>1.9</td>
</tr>
<tr>
<td>Input High Voltage, VIL Max.</td>
<td>1.5, 13.5</td>
<td>10</td>
<td>4</td>
</tr>
<tr>
<td>Input Current IN Min.</td>
<td>0.5, 4.5</td>
<td>5</td>
<td>1.9</td>
</tr>
<tr>
<td>Input Current IN Max.</td>
<td>1.5, 16.5</td>
<td>15</td>
<td>7</td>
</tr>
</tbody>
</table>

| DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ C$: Input $t_h, t_r = 20\, \text{ns}$, $C_L = 50\, \text{pF}$, $R_L = 200\, \text{kΩ}$ |

<table>
<thead>
<tr>
<th>CHARACTERISTIC</th>
<th>$V_{DD}$ (V)</th>
<th>LIMITS</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Propagation Delay Time, $t_{PHL, t_{PLH}}$</td>
<td>5</td>
<td>—</td>
<td>200</td>
</tr>
<tr>
<td>Astable, Astable to Osc. Out</td>
<td>10</td>
<td>—</td>
<td>100</td>
</tr>
<tr>
<td></td>
<td>15</td>
<td>—</td>
<td>80</td>
</tr>
<tr>
<td>Astable, Astable to O, $\overline{O}$</td>
<td>5</td>
<td>—</td>
<td>350</td>
</tr>
<tr>
<td></td>
<td>10</td>
<td>—</td>
<td>175</td>
</tr>
<tr>
<td></td>
<td>15</td>
<td>—</td>
<td>125</td>
</tr>
<tr>
<td>+ or - Trigger to O, $\overline{O}$</td>
<td>5</td>
<td>—</td>
<td>500</td>
</tr>
<tr>
<td></td>
<td>10</td>
<td>—</td>
<td>225</td>
</tr>
<tr>
<td></td>
<td>15</td>
<td>—</td>
<td>150</td>
</tr>
<tr>
<td>Retrigger to O, $\overline{O}$</td>
<td>5</td>
<td>—</td>
<td>300</td>
</tr>
<tr>
<td></td>
<td>10</td>
<td>—</td>
<td>150</td>
</tr>
<tr>
<td></td>
<td>15</td>
<td>—</td>
<td>100</td>
</tr>
<tr>
<td>External Reset to O, $\overline{O}$</td>
<td>5</td>
<td>—</td>
<td>250</td>
</tr>
<tr>
<td></td>
<td>10</td>
<td>—</td>
<td>100</td>
</tr>
<tr>
<td></td>
<td>15</td>
<td>—</td>
<td>60</td>
</tr>
<tr>
<td>Transition Time, $t_{PLH, t_{PHL}}$</td>
<td>5</td>
<td>—</td>
<td>100</td>
</tr>
<tr>
<td>Osc. Out, O, $\overline{O}$</td>
<td>10</td>
<td>—</td>
<td>50</td>
</tr>
<tr>
<td></td>
<td>15</td>
<td>—</td>
<td>40</td>
</tr>
<tr>
<td>Minimum Input Pulse Width, $t_w$</td>
<td>5</td>
<td>—</td>
<td>200</td>
</tr>
<tr>
<td></td>
<td>10</td>
<td>—</td>
<td>80</td>
</tr>
<tr>
<td></td>
<td>15</td>
<td>—</td>
<td>50</td>
</tr>
<tr>
<td>+ Trigger, - Trigger</td>
<td>5</td>
<td>—</td>
<td>100</td>
</tr>
<tr>
<td></td>
<td>10</td>
<td>—</td>
<td>50</td>
</tr>
<tr>
<td></td>
<td>15</td>
<td>—</td>
<td>30</td>
</tr>
<tr>
<td>Reset</td>
<td>5</td>
<td>—</td>
<td>300</td>
</tr>
<tr>
<td></td>
<td>10</td>
<td>—</td>
<td>115</td>
</tr>
<tr>
<td></td>
<td>15</td>
<td>—</td>
<td>75</td>
</tr>
<tr>
<td>Retrigger</td>
<td>5</td>
<td>—</td>
<td>270</td>
</tr>
<tr>
<td></td>
<td>10</td>
<td>—</td>
<td>18</td>
</tr>
<tr>
<td></td>
<td>15</td>
<td>—</td>
<td>9</td>
</tr>
<tr>
<td></td>
<td>5</td>
<td>—</td>
<td>325</td>
</tr>
<tr>
<td></td>
<td>10</td>
<td>—</td>
<td>9</td>
</tr>
<tr>
<td></td>
<td>15</td>
<td>—</td>
<td>4</td>
</tr>
<tr>
<td>Q or $\overline{Q}$ Deviation from 50% Duty Factor</td>
<td>5</td>
<td>±0.5</td>
<td>±1</td>
</tr>
<tr>
<td></td>
<td>10</td>
<td>±0.5</td>
<td>±1</td>
</tr>
<tr>
<td></td>
<td>15</td>
<td>±0.1</td>
<td>±0.5</td>
</tr>
<tr>
<td>Input Capacitance, $C_{IN}$</td>
<td>Any Input</td>
<td>—</td>
<td>5</td>
</tr>
</tbody>
</table>

---

**Fig. 10**—Typical transition time as a function of load capacitance.

**Fig. 11**—Typical astable oscillator or $Q, \overline{Q}$ period accuracy vs. supply voltage.

**Fig. 12**—Typical astable oscillator or $Q, \overline{Q}$ period accuracy vs. supply voltage.

**Fig. 13**—Typical astable oscillator or $Q, \overline{Q}$ period accuracy vs. supply voltage.
CD4047B Types

1. Astable Mode Design Information
   A. Unit-to-Unit Transfer-Voltage Variations — The following analysis presents variations from unit to unit as a function of transfer-voltage (V_{TR}) shift (33% - 67% V_{DD}) for free-running (astable) operation.

   \[
   t_1 = -\frac{RC}{V_{DD} + V_{TR}} \quad \text{typically, } t_1 = 1.1 \text{ RC}
   \]

   \[
   t_2 = -\frac{RC}{2V_{DD} - V_{TR}} \quad \text{typically, } t_2 = 1.1 \text{ RC}
   \]

   \[
   t_A = 2(t_1 + t_2) = -2 RC \ln \left(\frac{V_{TR}V_{DD} - V_{TR}}{(V_{DD} + V_{TR})2V_{DD} - V_{TR}}\right)
   \]

   Typ: \( V_{TR} = 0.5 \ V_{DD} \) \( t_A = 4.40 \text{ RC} \)
   Min: \( V_{TR} = 0.33 \ V_{DD} \) \( t_A = 4.62 \text{ RC} \)
   Max: \( V_{TR} = 0.67 \ V_{DD} \) \( t_A = 4.62 \text{ RC} \)

   thus if \( t_A = 4.40 \text{ RC} \) is used, the variation \( \pm 5\% \) will be ±0\% due to variations in transfer voltage.

   B. Variations Due to \( V_{DD} \) and Temperature Changes — In addition to variations from unit to unit, the astable period varies with \( V_{DD} \) and temperature. Typical variations are presented in graphical form in Figs. 31 to 33 with 10\% as reference for voltage variations curves and 25\(^\circ\)C as reference for temperature variations curves.

   II. Monostable Mode Design Information
   The following analysis presents variations from unit to unit as a function of transfer-voltage (V_{TR}) shift (33% - 67% V_{DD}) for one-shot (monostable) operation.

   \[
   t_1' = -\frac{RC}{2V_{DD}} \ln \frac{V_{TR}}{V_{DD} - V_{TR}} \quad \text{typically, } t_1' = 1.38 \text{ RC}
   \]

   \[
   t_M = (t_1' + t_2)
   \]

   \[
   t_M = -\frac{RC}{2V_{DD}} \ln \left(\frac{V_{TR}V_{DD} - V_{TR}}{(2V_{DD} - V_{TR})V_{DD}}\right)
   \]

   where \( t_M \) = Monostable mode pulse width. Values for \( t_M \) are as follows:

   Typ: \( V_{TR} = 0.5 \ V_{DD} \) \( t_M = 2.48 \text{ RC} \)
   Min: \( V_{TR} = 0.33 \ V_{DD} \) \( t_M = 2.71 \text{ RC} \)
   Max: \( V_{TR} = 0.67 \ V_{DD} \) \( t_M = 2.48 \text{ RC} \)

   thus if \( t_M = 2.48 \text{ RC} \) is used, the variation will be ±9.3\%, ±0\% due to variations in transfer voltage.

   Note:
   In the monostable mode, the first positive half cycle has a duration of \( t_M \); succeeding durations are \( t_A/2 \).

   In addition to variations from unit to unit, the monostable pulse width varies with \( V_{DD} \) and temperature. These variations are presented in graphical form in Figs. 34 to 36 with 10 V as reference for voltage-variation curves and 25\(^\circ\)C as reference for temperature-variation curves.
III. Retrigger Mode Operation

The CD4047B can be used in the retrigger mode to extend the output-pulse duration, or to compare the frequency of an input signal with that of the internal oscillator. In the retrigger mode the input pulse is applied to terminal 12, and the output is taken from terminal 10 or 11. As shown in Fig. 34 normal monostable action is obtained when one retrigger pulse is applied. Extended pulse duration is obtained when more than one pulse is applied.

![Fig. 34—Retrigger-mode waveforms.](image)

For two input pulses, $t_{RE} = t_1' + t_1 + 2t_2$. For more than two pulses, the output pulse width is an integral number of time periods, with the first time period being $t_1' + t_2$, typically, 2.48RC, and all subsequent time periods being $t_1 + t_2$, typically, 2.2RC.

IV. External Counter Option

Time $t_M$ can be extended by any amount with the use of external counting circuitry. Advantages include digitally controlled pulse duration, small timing capacitors for long time periods, and extremely fast recovery time. A typical implementation is shown in Fig. 35. The pulse duration at the output is

$$t_{EXT} = (N - 1)(t_A) + (t_M + t_A/2)$$

where $t_{ext} =$ pulse duration of the circuitry, and $N$ is the number of counts used.

![Fig. 35—Implementation of external counter option.](image)

V. Timing-Component Limitations

The capacitor used in the circuit should be non-polarized and have low leakage (i.e., the parallel resistance of the capacitor should be at least an order of magnitude greater than the external resistor used). There is no upper or lower limit for either $R$ or $C$ value to maintain oscillation.

However, in consideration of accuracy, $C$ must be much larger than the CMOS "ON" resistance in series with it, which typically is hundreds of ohms. In addition, with very large values of $R$, some short-term instability with respect to time may be noted.

The recommended values for these components to maintain agreement with previously calculated formulas without trimming should be:

- $C > 100$ pF, up to any practical value, for astable modes;
- $C > 1000$ pF, up to any practical value for monostable modes.

$10 \, k\Omega < R \leq 1 \, M\Omega$

VI. Power Consumption

In the standby mode (Monostable or Astable), power dissipation will be a function of leakage current in the circuit, as shown in the static electrical characteristics. For dynamic operation, the power needed to charge the external timing capacitor $C$ is given by the following formulae:

- **Astable Mode:**
  $$P = 2CV^2L, (\text{Output at terminal No. 13})$$
  $$P = 4CV^2L, (\text{Output at terminal Nos. 10 and 11})$$

- **Monostable Mode:**
  $$P = (2.9CV^2)(\text{Duty Cycle})$$

(Output at terminal Nos. 10 and 11)

The circuit is designed so that most of the total power is consumed in the external components. In practice, the lower the values of frequency and voltage used, the closer the actual power dissipation will be to the calculated value.

Because the power dissipation does not depend on $R$, a design for minimum power dissipation would be a small value of $C$. The value of $R$ would depend on the desired period (within the limitations discussed above). See Figs. 27, 28, and 29 for typical power consumption in astable mode.

![Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^-3 inch).](image)

4-10
(0.102-0.254)

80-88
(2.032-2.255)

75-84
(1.950-2.134)

Chip dimensions and pad layout for CD4047B
## PACKAGING INFORMATION

<table>
<thead>
<tr>
<th>Orderable Device</th>
<th>Status (1)</th>
<th>Package Type</th>
<th>Package Drawing</th>
<th>Pins</th>
<th>Package Qty</th>
<th>Eco Plan (2)</th>
<th>Lead/Ball Finish</th>
<th>MSL Peak Temp (3)</th>
<th>Op Temp (°C)</th>
<th>Device Marking (4/5)</th>
<th>Samples</th>
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</tr>
</tbody>
</table>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) **MSL, Peak Temp.** - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) **Lead/Ball Finish** - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF CD4047B, CD4047B-MIL:**

- Catalog: CD4047B
- Military: CD4047B-MIL

**NOTE:** Qualified Version Definitions:

- **Catalog** - TI's standard catalog product
- **Military** - QML certified for Military and Defense Applications
## TAPE AND REEL INFORMATION

### TAPE DIMENSIONS

- **A0**: Dimension designed to accommodate the component width
- **B0**: Dimension designed to accommodate the component length
- **K0**: Dimension designed to accommodate the component thickness
- **W**: Overall width of the carrier tape
- **P1**: Pitch between successive cavity centers

### REEL DIMENSIONS

- **Reel Diameter**
- **Reel Width (W1)**

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

- **Sprocket Holes**
- **User Direction of Feed**
- **Pocket Quadrants**

### PACKAGE MATERIALS INFORMATION

*All dimensions are nominal*

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<thead>
<tr>
<th>Device</th>
<th>Package Type</th>
<th>Package Drawing</th>
<th>Pins</th>
<th>SPQ</th>
<th>Reel Diameter (mm)</th>
<th>Reel Width W1 (mm)</th>
<th>A0 (mm)</th>
<th>B0 (mm)</th>
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<th>P1 (mm)</th>
<th>W (mm)</th>
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*All dimensions are nominal*
JD (R-CDIP-T14) CERAMIC SIDE-BRAZE DUAL-IN-LINE

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Controlling dimension: inch.
D. Leads within 0.005 (0.13) radius of true position (TP) at gage plane with maximum material condition and unit installed.
E. Angle applies to spread leads prior to installation.
F. Outlines on which the seating plane is coincident with the plane (standoff = 0), terminals lead standoffs are not required, and lead shoulder may equal lead width along any part of the lead above the seating/base plane.
G. Body width does not include particles of packing materials.
H. A visual index feature must be located within the cross-hatched area.

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MECHANICAL DATA

NS (R-PDSO-G**)  PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

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<th>DIM</th>
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NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.
Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.
NOTES:

1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

2. This drawing is subject to change without notice.

3. This package is hermetically sealed with a ceramic lid using glass frit.

4. Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.

EXAMPLE BOARD LAYOUT

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE

LAND PATTERN EXAMPLE
NON-SOLDER MASK DEFINED
SCALE: 5X

SEE DETAIL A
SEE DETAIL B

12X (.100 )
[2.54]

14X (Ø .039)
[1]

SYMM

DETAL A
SCALE: 15X

DETAIL B
13X, SCALE: 15X

(Ø .063)
[1.6]
NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
   ▶ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0.15) each side.
   ▶ Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0.43) each side.
E. Reference JEDEC MS-012 variation AB.
NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC-7351 is recommended for alternate designs.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.
NOTES:

A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
B. This drawing is subject to change without notice.

⚠️ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 each side.

⚠️ Body width does not include interlead flash. Interlead flash shall not exceed 0.25 each side.
E. Falls within JEDEC MO-153
N (R—PDIP—T**)  
PLASTIC DUAL—IN—LINE PACKAGE

NOTES:  
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS—001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

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